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NTE2931 MOSFET N-Channel, Enhancement Mode High Speed Switch

Features:

- Avalanche Rugged Technology
- Rugged Gate Oxide Technology
- Lower Input Capacitance
- Improved Gate Charge
- Extended Safe Operating Area
- Lower $R_{DS(on)}$: 0.144Ω Typ
- Lower Leakage Current: 10μA (Max) @ $V_{DS} = 200V$

Absolute Maximum Ratings:

| | |
|--|-------------------------------|
| Drain-to-Source Voltage, V_{DSS} | 200V |
| Drain Current, I_D | |
| Continuous | |
| $T_C = +25^\circ C$ | 12.8A |
| $T_C = +100^\circ C$ | 8.1A |
| Pulsed (Note 1) | 80A |
| Total Power Dissipation ($T_C = +25^\circ C$), P_D | 73W |
| Derate Above $25^\circ C$ | 0.59W/ $^\circ C$ |
| Gate-Source Voltage, V_{GS} | $\pm 30V$ |
| Single Pulsed Avalanche Energy (Note 2), E_{AS} | 328mJ |
| Avalanche Current (Note 1), I_{AR} | 12.8A |
| Repetitive Avalanche Energy (Note 1), E_{AR} | 7.3mJ |
| Peak Diode Recovery dv/dt (Note 3), dv/dt | 5.0V/ns |
| Operating Junction Temperature Range, T_J | -55° to $+150^\circ C$ |
| Storage Temperature Range, T_{stg} | -55° to $+150^\circ C$ |
| Maximum Lead Temperature (During Soldering, 1/8" from case, 5sec), T_L | $+300^\circ C$ |
| Thermal Resistance, Junction-to-Case, R_{thJC} | 1.7 $^\circ C/W$ |
| Thermal Resistance, Junction-to-Ambient, R_{thJA} | 40 $^\circ C/W$ |

Note 1. Repetitive Rating: Pulse width limited by maximum junction temperature.

Note 2. $L = 3mH$, $I_{AS} = 12.8A$, $V_{DD} = 50V$, $R_G = 27\Omega$, Starting $T_J = +25^\circ C$.

Note 3. $I_{SD} \leq 18A$, $di/dt \leq 260A/\mu s$, $V_{DD} \leq V_{(BR)DSS}$, Starting $T_J = +25^\circ C$.

Electrical Characteristics: ($T_C = +25^\circ\text{C}$ unless otherwise specified)

| Parameter | Symbol | Test Conditions | Min | Typ | Max | Unit |
|---|-----------------------------------|---|-----|------|------|--------------------|
| Drain–Source Breakdown Voltage | BV_{DSS} | $V_{GS} = 0V, I_D = 250\mu A$ | 200 | – | – | V |
| Breakdown Voltage Temperature Coefficient | $\Delta V_{(BR)DSS} / \Delta T_J$ | $I_D = 250\mu A$ | – | 0.26 | – | $V/^\circ\text{C}$ |
| Gate Threshold Voltage | $V_{GS(th)}$ | $V_{DS} = 5V, I_D = 250\mu A$ | 2.0 | – | 4.0 | V |
| Gate–Source Leakage Forward | I_{GSS} | $V_{GS} = 30V$ | – | – | 100 | nA |
| Gate–Source Leakage Reverse | I_{GSS} | $V_{GS} = -30V$ | – | – | -100 | nA |
| Drain–to–Source Leakage Current | I_{DSS} | $V_{DS} = 200V$ | – | – | 10 | μA |
| | | $V_{DS} = 160V, T_C = +125^\circ\text{C}$ | – | – | 100 | μA |
| Static Drain–Source ON Resistance | $R_{DS(on)}$ | $V_{GS} = 10V, I_D = 6.4A, \text{Note 4}$ | – | – | 0.18 | Ω |
| Forward Transconductance | g_{fs} | $V_{DS} = 40V, I_D = 6.4A, \text{Note 4}$ | – | 8.87 | – | mhos |
| Input Capacitance | C_{iss} | $V_{GS} = 0V, V_{DS} = 25V, f = 1\text{MHz}$ | – | 1160 | 1500 | pF |
| Output Capacitance | C_{oss} | | – | 210 | 250 | pF |
| Reverse Transfer Capacitance | C_{rss} | | – | 94 | 110 | pF |
| Turn–On Delay Time | $t_{d(on)}$ | $V_{DD} = 100V, I_D = 18A, R_G = 9.1\Omega, \text{Note 4, Note 5}$ | – | 17 | 40 | ns |
| Rise Time | t_r | | – | 16 | 40 | ns |
| Turn–Off Delay Time | $t_{d(off)}$ | | – | 48 | 110 | ns |
| Fall Time | t_f | | – | 24 | 60 | ns |
| Total Gate Charge | Q_g | $V_{GS} = 10V, I_D = 18A, V_{DS} = 160V, \text{Note 4, Note 5}$ | – | 44 | 58 | nC |
| Gate–Source Charge | Q_{gs} | | – | 10.4 | – | nC |
| Gate–Drain (“Miller”) Charge | Q_{gd} | | – | 27.1 | – | nC |
| Source–Drain Diode Ratings and Characteristics | | | | | | |
| Continuous Source Current | I_S | (Body Diode) | – | – | 12.8 | A |
| Pulse Source Current | I_{SM} | (Body Diode) Note 1 | – | – | 80 | A |
| Diode Forward Voltage | V_{SD} | $T_J = +25^\circ\text{C}, I_S = 12.8A, V_{GS} = 0V, \text{Note 4}$ | – | – | 1.5 | V |
| Reverse Recovery Time | t_{rr} | $T_J = +25^\circ\text{C}, I_F = 18A, di_F/dt = 100A/\mu s, \text{Note 4}$ | – | 195 | – | ns |
| Reverse Recovery Charge | Q_{rr} | | – | 1.35 | – | μC |

Note 1. Repetitive Rating: Pulse width limited by maximum junction temperature.

Note 4. Pulse Test: Pulse Width = $250\mu s$, Duty Cycle $\leq 2\%$.

Note 5. Essentially independent of operating temperature.

